

IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

In re the Application of: **Koichi KUSAKAWA, et al.**

Serial No.: **Not Yet Assigned**
(§371 of International Application PCT/JP04/16468)

Filed: **April 28, 2006**

For: **RESIN COMPOSITION FOR FOAM MOLDING, FOAM AND METHOD FOR
PRODUCING THE FOAM**

PRELIMINARY AMENDMENT

Commissioner for Patents
P.O. Box 1450
Alexandria, VA 22313-1450

Date: April 28, 2006

Sir:

Prior to calculation of the filing fee and examination of this application, please amend the
above-identified patent application as follows: